

20 February 2025

## 4DS Successfully Completes Share Purchase Plan

- **4DS has completed the SPP following a successful \$6 million Placement on 17 January 2025**
- **Valid applications received for approximately \$4.76 million under the SPP**
- **SPP applications to be scaled back to \$2.6 million**
- **Total proceeds of \$8.6 million Placement and SPP will be used to progress the Design Agreement with Infineon Technologies LLC (Infineon) and imec**

**4DS Memory Limited** (ASX:4DS) (**4DS** or the **Company**) is pleased to announce that it has successfully completed its Share Purchase Plan (**SPP**) which closed, oversubscribed, on 14 February 2025.

In conjunction with the completion of the Placement, the Company announced a SPP to offer existing and eligible shareholders on the record date, with a registered address in Australia or New Zealand, the opportunity to subscribe for up to \$30,000 worth of new shares at the same price as the Placement (\$0.036 per share), without any brokerage or other costs.

Each issued share under the SPP will also have a 1:1 attaching unlisted option with an exercise price of \$0.036, expiring on 28 February 2028.

At the closing of the SPP at 5pm AEDT on 14 February 2025, 4DS had received valid applications for approximately \$4.76 million and will now undertake a scale back on applications by 47.82% to achieve the new SPP target of \$2.6 million, allowing for \$600,000 in oversubscriptions which was the maximum amount available under the Company's existing placement capacity under ASX Listing Rule 7.1 when considering the attaching options. As the minimum amount under the SPP was \$2,000, those shareholders who applied for that amount will not be scaled back.

Executive Chairman David McAuliffe decided not to participate in the SPP as it was oversubscribed and wanted to give shareholders the right to the attached unlisted options. Mr McAuliffe will buy shares on market during the next available trading window.

The Company expects the new shares under the SPP will be issued and holding statements dispatched on 21 February 2025 and trading of the new shares is expected to commence on 24 February 2025.

Refunds are expected to be paid by direct credit (for those shareholders who have provided the Company with their bank details) or cheque on or around 24 February 2025. No interest will be paid on refunds.

The \$8.6 million raised from the Placement and SPP will now be used for working capital requirements under the design and services agreement with Infineon, ongoing investment in development with imec, general working capital and offer costs.

The Board thanks shareholders for the highly encouraging level of participation in the SPP.

### 4DS Interactive Investor Hub

If you have any questions on this announcement or any past 4DS announcements, check out our Investor Hub. Like, comment, ask a question and view video summaries on important announcements. Shareholders can link through to the Investor Hub via: [announcements.4dsmemory.com](https://announcements.4dsmemory.com)

### ENDS

Authorised for release by the Board.

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## About 4DS

**4DS Memory Limited (ASX: 4DS)**, with facilities located in Silicon Valley, is a semiconductor technology company bringing high bandwidth, high endurance, persistent non-volatile memory to advanced CMOS process nodes. Its technology, known as Interface Switching ReRAM, features tunable persistence and low energy per bit for today's most challenging compute intensive and AI processor applications. Established in 2007, 4DS owns a patented IP portfolio, comprising 34 USA patents, and is the first company to develop PCMO ReRAM, on an advanced CMOS processing node. 4DS has three important industry relationships: a development agreement with Belgium based imec, a world leading research and innovation hub in nano electronics and digital technologies; a design agreement with Infineon Technologies AG, Germany's largest semiconductor manufacturer and one of the ten largest semiconductor manufacturers worldwide; and a joint development agreement with Western Digital subsidiary HGST, a global leader in storage solutions.

For more information, please visit [www.4dsmemory.com](http://www.4dsmemory.com)

### Disclaimer

This release contains certain forward-looking statements that are based on the Company's management's beliefs, assumptions and expectations and on information currently available to management. Such forward looking statements involve known and unknown risks, uncertainties, and other factors which may cause the actual results or performance of 4DS to be materially different from the results or performance expressed or implied by such forward looking statements. Such forward looking statements are based on numerous assumptions regarding the Company's present and future business strategies and the political and economic environment in which 4DS will operate in the future, which are subject to change without notice. Past performance is not necessarily a guide to future performance and no representation or warranty is made as to the likelihood of achievement or reasonableness of any forward-looking statements or other forecast. To the full extent permitted by law, 4DS and its directors, officers, employees, advisers, agents and intermediaries disclaim any obligation or undertaking to release any updates or revisions to information to reflect any change in any of the information contained in this release (including, but not limited to, any assumptions or expectations set out in the release).

You should not place undue reliance on these forward-looking statements. Except as required by law or regulation (including the ASX Listing Rules) we undertake no obligation to update these forward-looking statements.